

# Status of SiD

Jan Strube  
CERN

on behalf of the SiD detector concept

# Outline

- Introduction to SiD
  - People
  - The detector concept
- Highlights from the DBD
  - Detector baseline choices / options
  - Software
  - Selected physics analysis results
- Summary / Outlook



# Introducing SiD



Co-spokesperson  
M. Stanitzki  
DESY



Co-spokesperson  
A. White  
UT Arlington

An international group studying a detector concept for LCs

SiD  
Detailed  
Baseline  
Report  
Editors

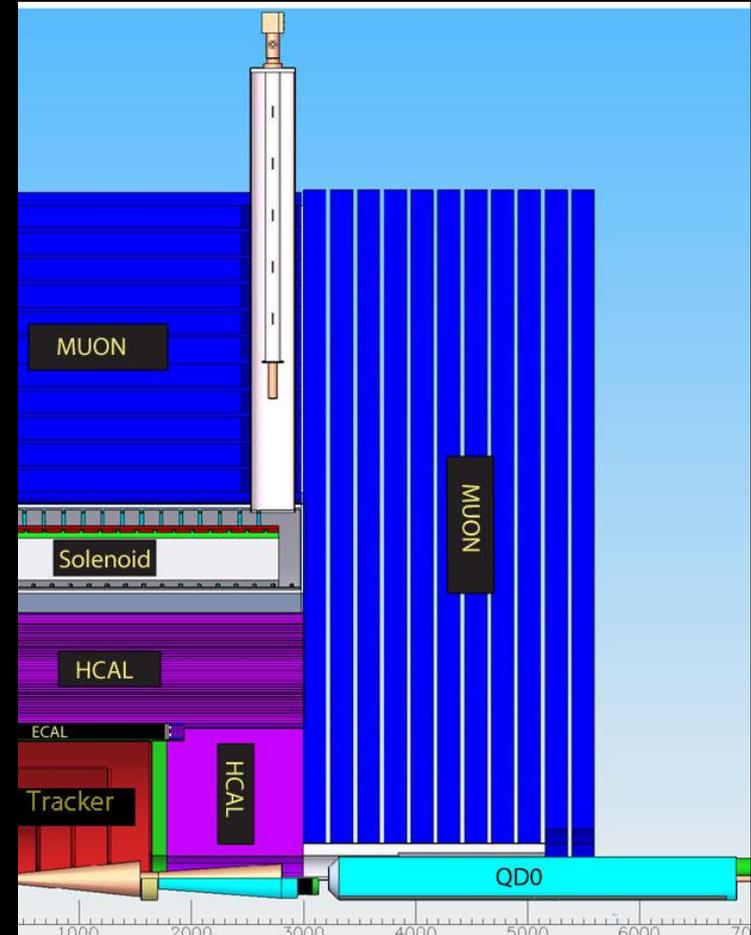


# The SiD Detector Concept at the ILC

*A compact, cost-constrained detector designed to make precision measurements and be sensitive to a wide range of new phenomena*

## Design Choices:

- Compact Design in a 5 T field
- Robust all-Silicon tracking with excellent momentum resolution
- Time-stamping for single bunch crossings
- Highly granular calorimetry optimized for Particle Flow
- Integrated Design: All parts work in tandem
- Iron flux return / muon identifier is part of SiD self-shielding



# Physics Requirements

## Momentum resolution

Higgs Recoil

$$\sigma(p_T)/p_T^2 \sim 2-5 \times 10^{-5} \text{ GeV}^{-1}$$

## Jet Energy Resolution

Separation of W/Z/H bosons:

Gauginos, Triple Gauge Coupling

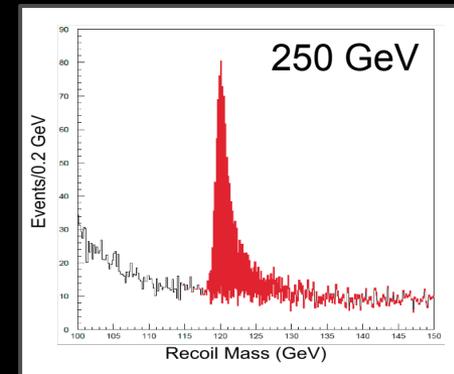
$$\sigma(E)/E = 3.5\%-5\%$$

## Flavor Tagging

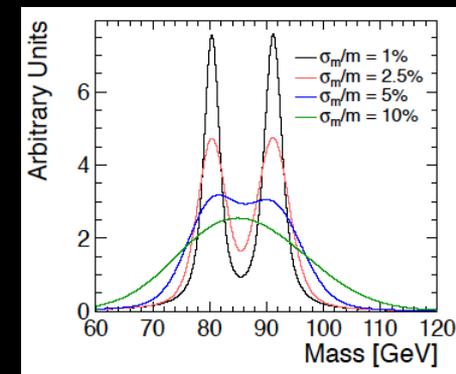
Higgs Branching ratios

$$\sigma_{r\phi} \approx 5 \mu\text{m} \oplus 10 \mu\text{m} / (p[\text{GeV}] \sin^{3/2}\theta)$$

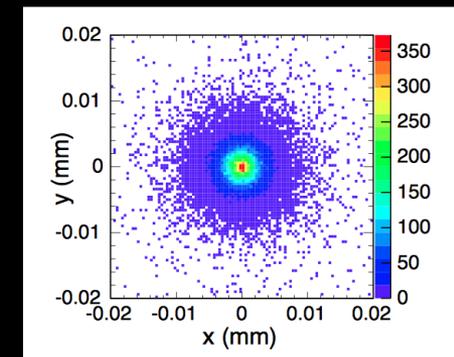
HZ  $\rightarrow \mu^+\mu^- + \text{anything}$



W-Z separation



primary vertices in ttH events



ILC  
1 TeV

# Milestones



Concept and its performance at various collision energies documented in several documents.  
SiD was validated by IDAG in 2009.



# The DBD

The DBD describes the baseline choices for all sub-detectors (except the vertex detector)

Options have been kept

This baseline is fully costed

Options offer better performance and/or lower cost

Not as mature as baseline choices

The DBD is a waypoint on the road to the SiD TDR and beyond.

R&D continues.

# Overview of Detector Baseline

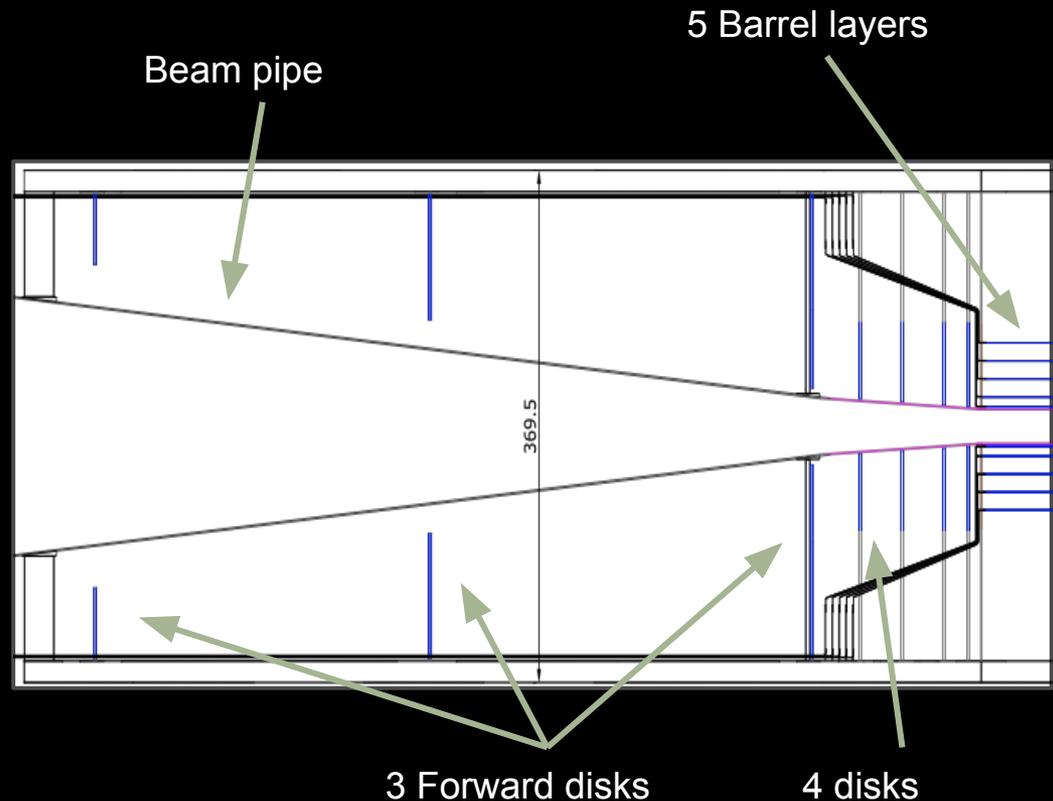
# Vertex Tracker

Excellent impact parameter resolution for reconstruction of secondary and tertiary vertices

Several technologies potentially meet the requirements: 3D, SOI, MAPS, hybrid pixels, DEPFET

5 pixel layers in barrel  
Innermost layer at 14 mm  
4 disks  
~ 20x20  $\mu\text{m}^2$  pixels

3 forward disks  
~ 50x50  $\mu\text{m}^2$  pixels



R&D for extremely low-mass support structures:  
All-silicon assembly, foam-based ladders (PLUME collaboration), carbon fibre supports

SiD is designed to make insertion and removal of the Vertex Detector straightforward.  
Allows to take advantage of the best possible technology.

# Pixel Technology Examples

Chronopix: Monolithic CMOS chip with time stamp memory for a whole bunch train.  
25x25  $\mu\text{m}^2$  pixels currently, 90 nm technology.

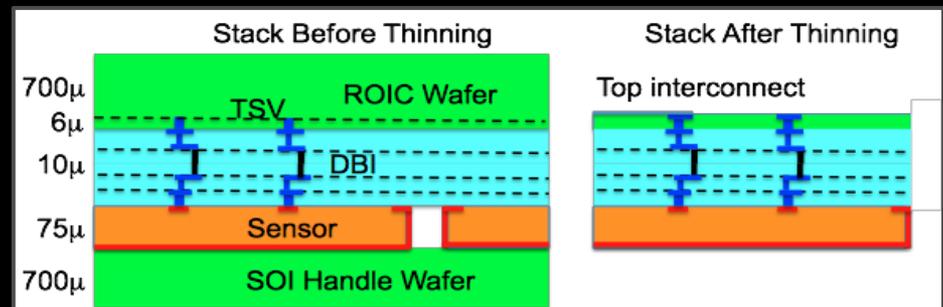
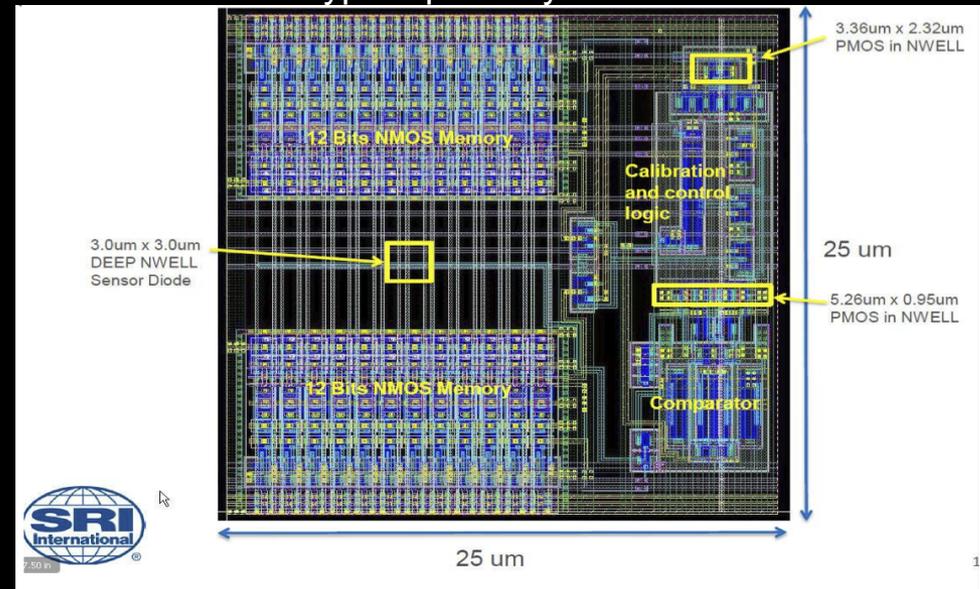
Full prototype to have 10x10  $\mu\text{m}^2$  or 15x15  $\mu\text{m}^2$ , will go to 45 nm technology.

See N. Sinev's talk on Tuesday morning

## 3D technology:

Top interconnect can be done in final topside aluminum patterning with low mass.  
Cables bump-bonded to end of ladders. Allows for all-silicon design.

Prototype 2 pixel layout



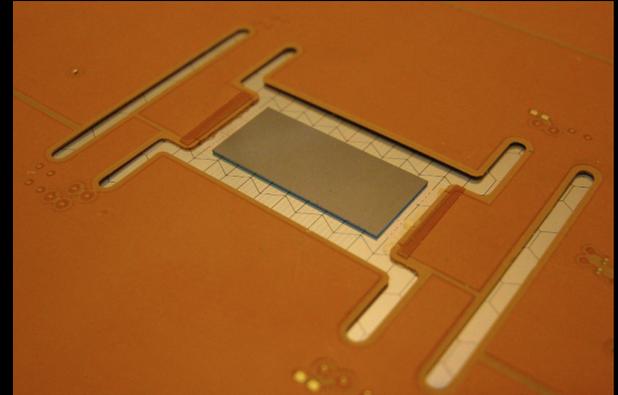
# KPiX - System on a chip

1024 channels prototype under test  
optimized for ILC  
(1 ms train, 5 Hz train repetition rate)

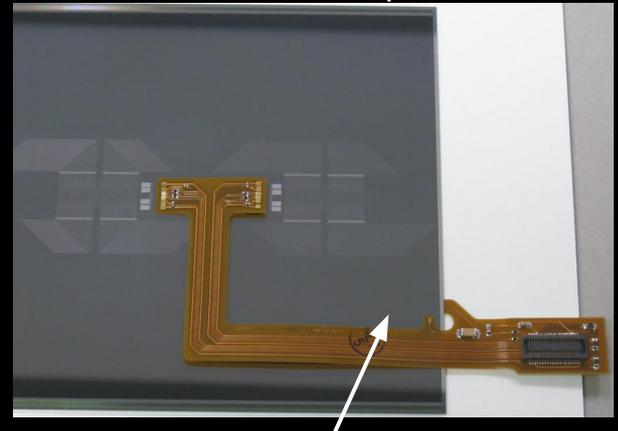
- Low noise dual range charge amplifier with; 17 bit dynamic range
- Low noise floor 0.15 fC (1000 e<sup>-</sup>)
- Designed for power modulation, average power < 20  $\mu$ W / channel
- Internal calibration system
- Up to four measurements per channel per train
- Versatile

Baseline for Tracker and ECAL.

KPiX as a Calorimeter chip



KPiX as a Tracker chip



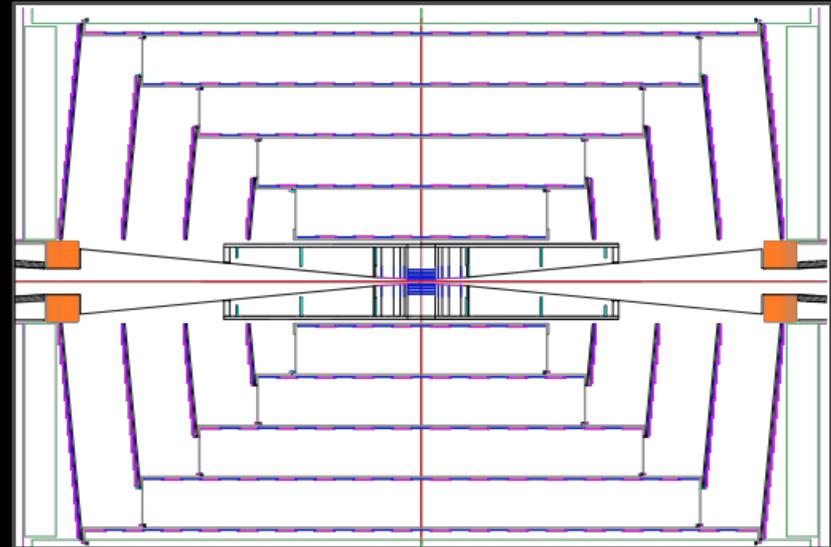
First revision of pigtail cable has been tested.  
Second revision has been ordered.

# Outer Tracker

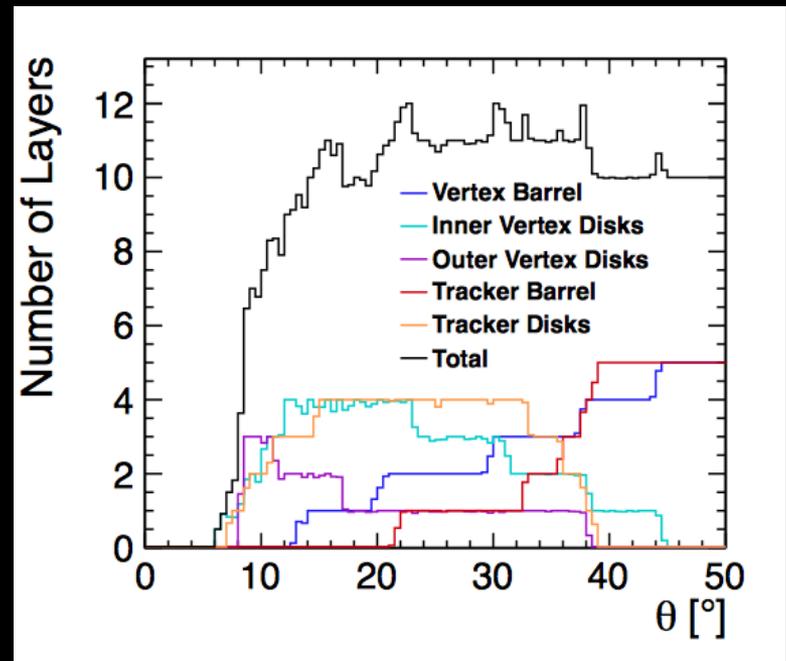
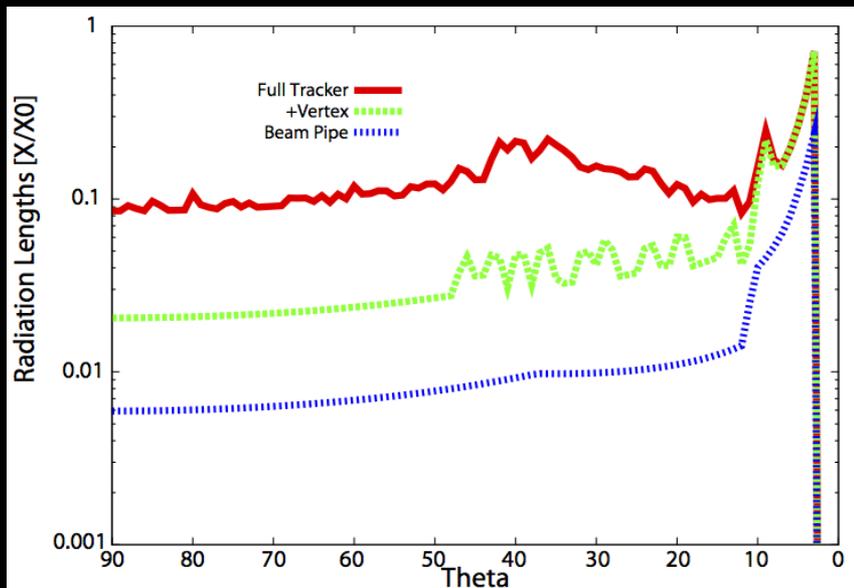
Low material budget  $\leftrightarrow$  excellent momentum resolution

In an all-silicon tracker, this means:

1. thin sensors
2. advanced integrated electronics
3. low-mass support
4. low power  $\leftrightarrow$  low-mass cooling

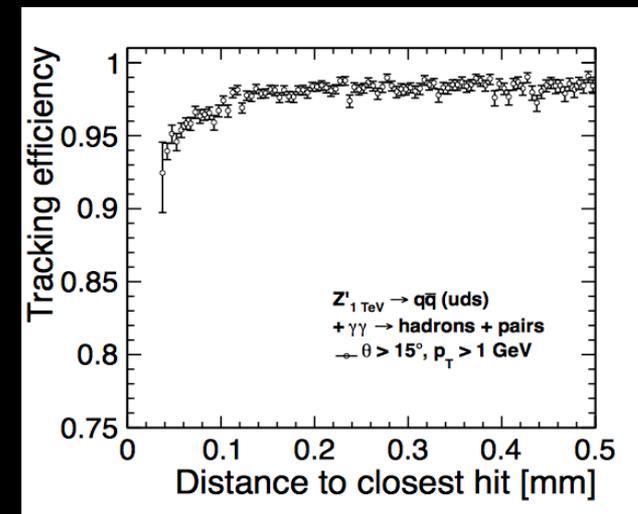
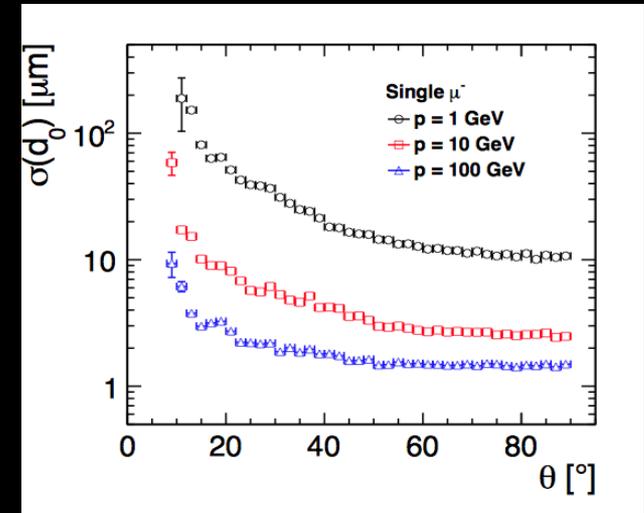
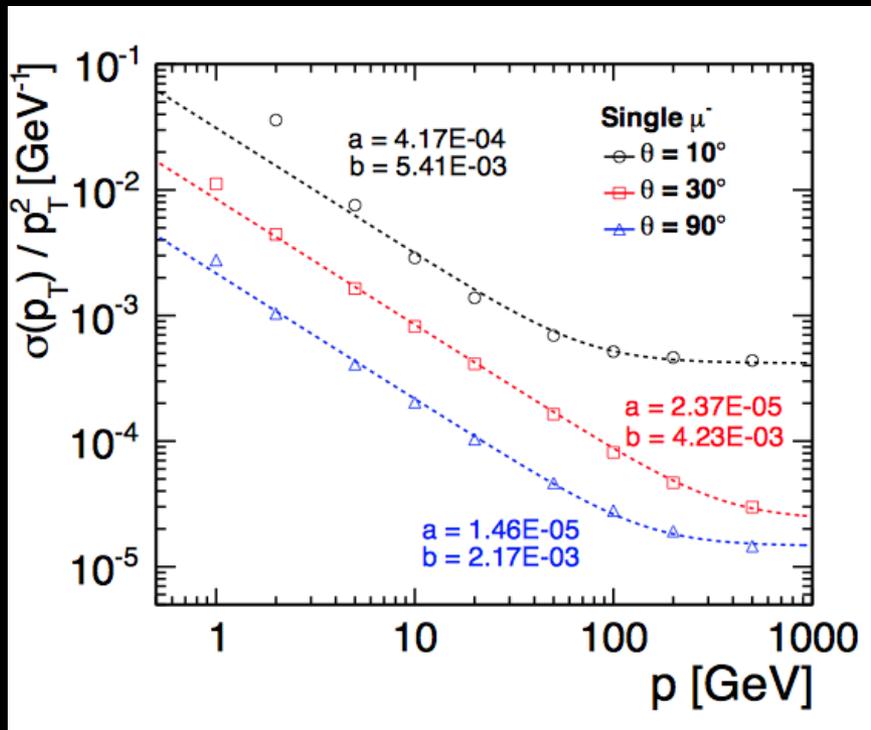


Hermetic coverage

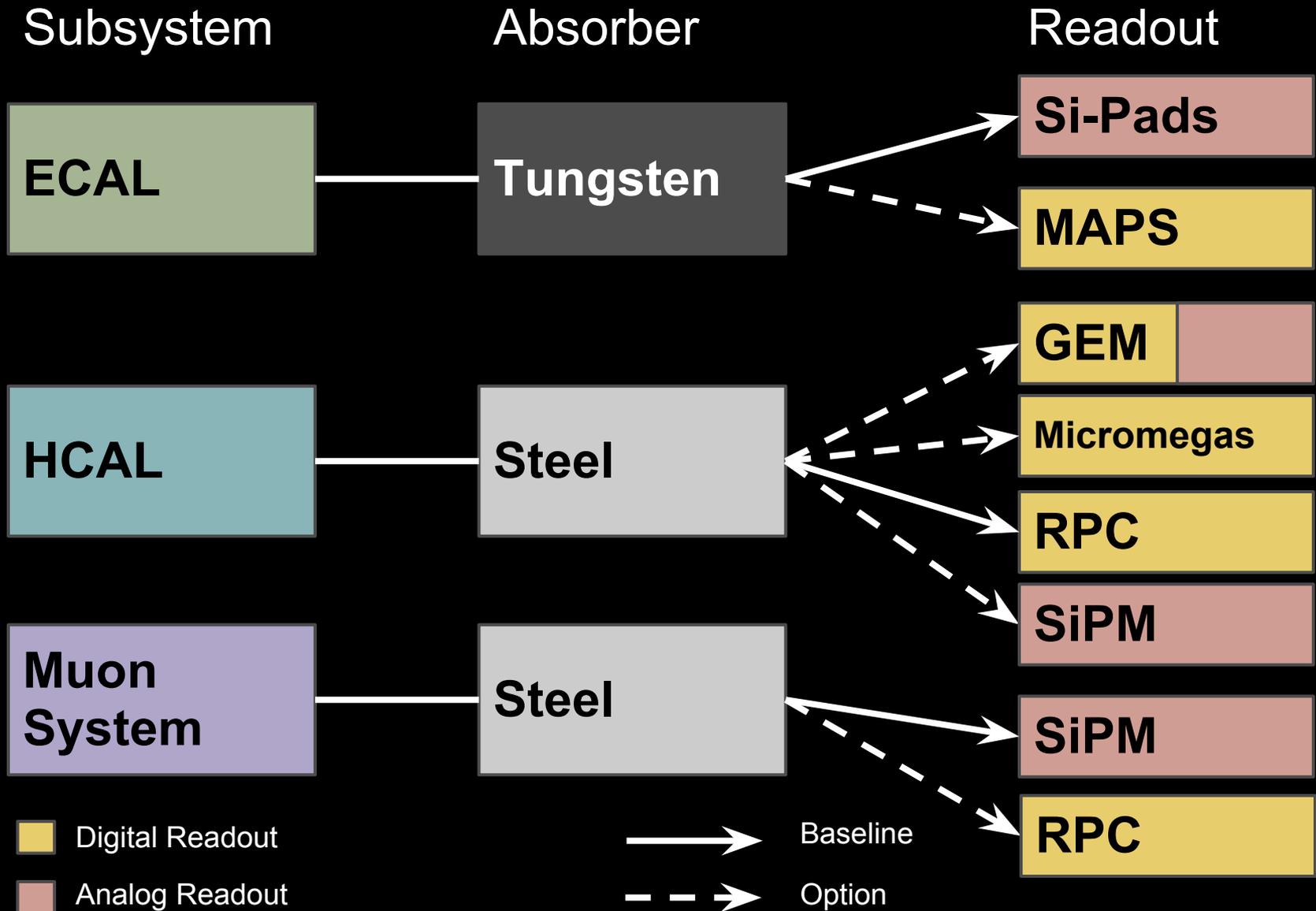


# Tracking Performance

Excellent momentum resolution, impact parameter resolution and track finding efficiency even in high-energy jets



# Calorimetry Tree



# Si-W ECal

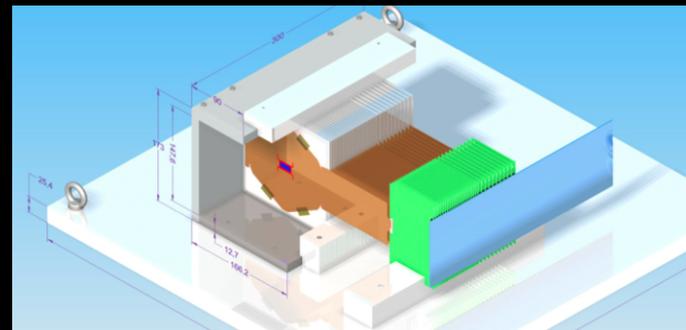
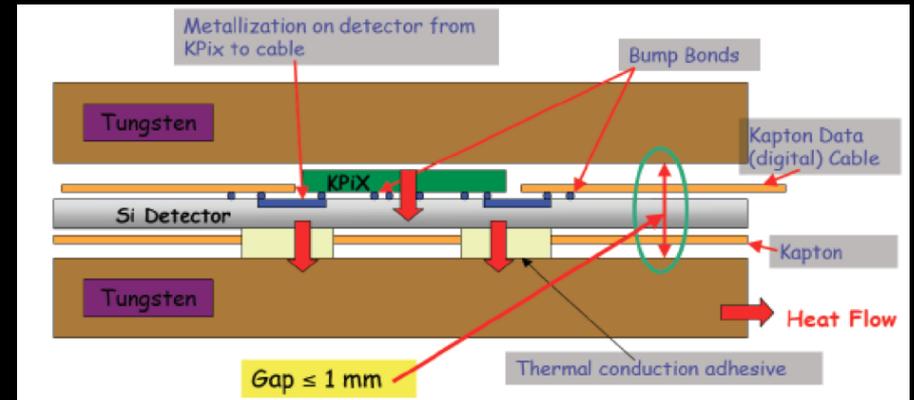
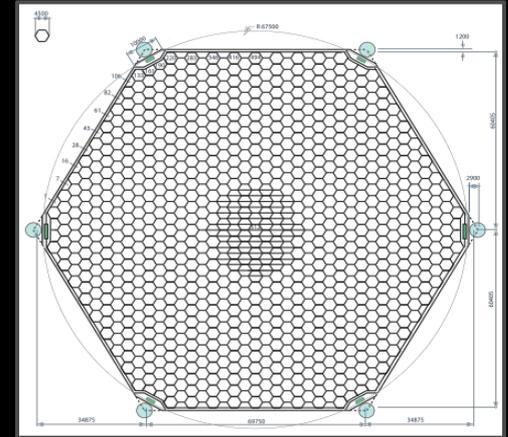
Highly segmented in lateral and transverse directions  
Hexagonal shapes  
Readout with KPiX chip

20 layers 2.5 mm W ( $5/7 X_0$ ),  
10 layers 5 mm W ( $10/7 X_0$ )  
1.25 mm gaps  $\rightarrow 29 X_0$ ,  $1 \lambda$   
 $\Delta E / E \approx 17\% / \sqrt{E}$

Scheduled for SLAC ESA beamline in  
July 2013, <15 of the full 30 layers;  
All layers for later running in 2013-14

The R&D provides the required baseline  
ECal components (except large-scale  
mechanics) – now nearly completed

See Jim Brau's talk on Tuesday afternoon.



# HCAL

Highly granular calorimeter - 1x1 cm<sup>2</sup> readout pads. World record for number of channels in hadron calorimetry already in test stack.

Baseline: Glass RPC, digital readout

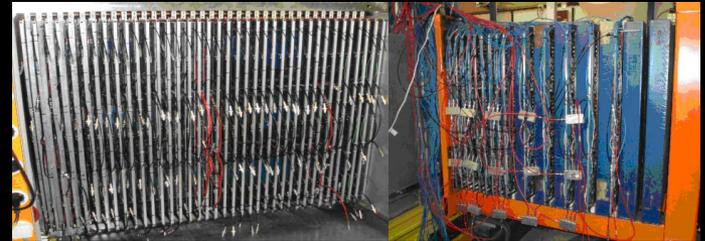
Technology successfully tested in beam tests in steel absorber stack at FNAL and in tungsten absorber stack at CERN

Data analysis is underway

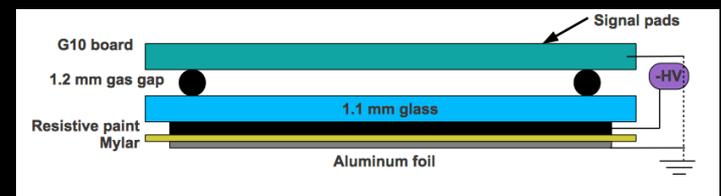
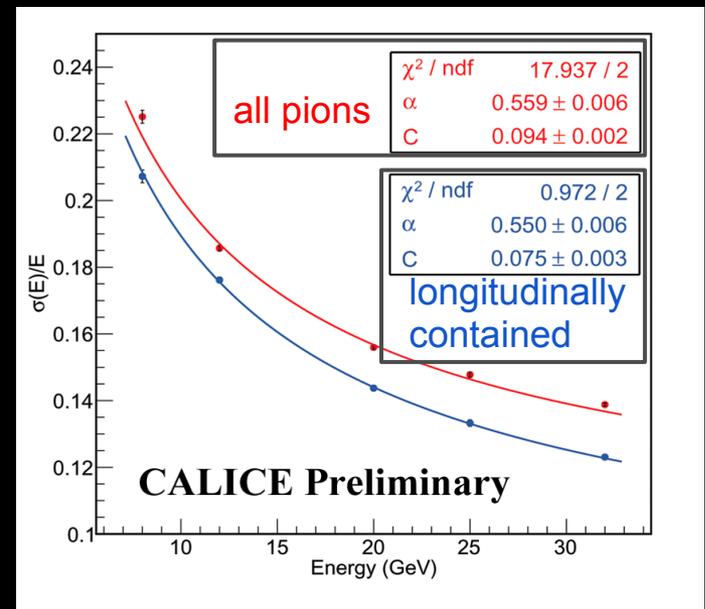
Operational experience drives further R&D: Single-glass RPC, low-resistivity glass for lower multiplicity, higher rate

See B. Bilki's talk on Wednesday afternoon and A. White's talk on GEMs on Thursday morning

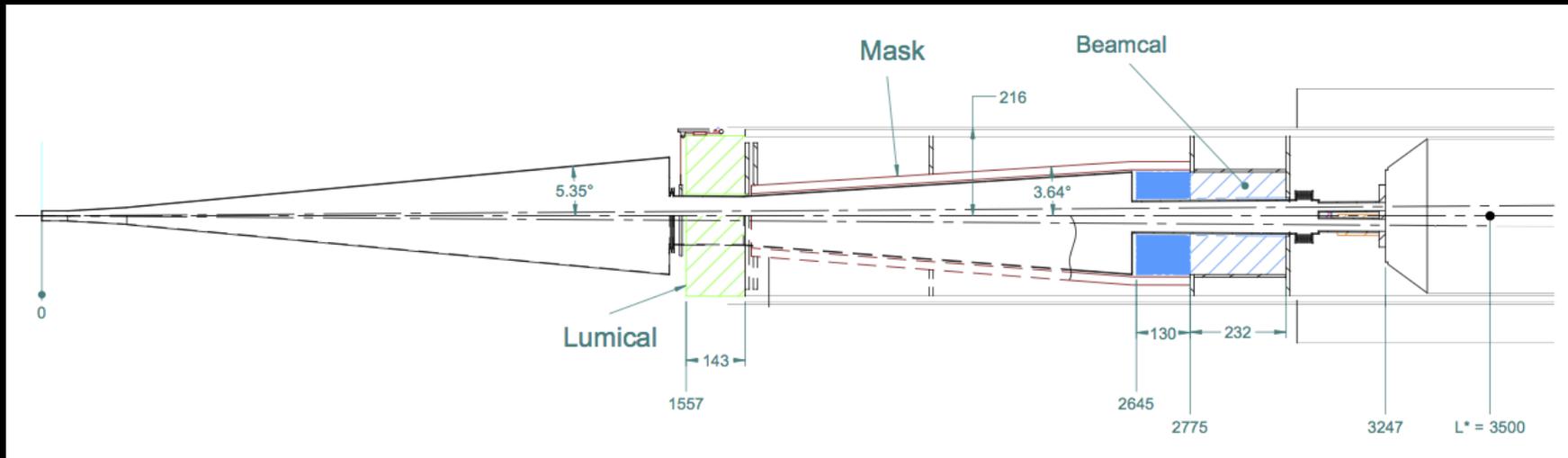
## HCAL in the Steel absorber stack at FNAL



## Energy resolution of pions



# Forward Systems

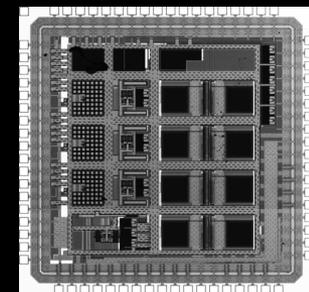


LumiCal:  $40 \text{ mrad} < \theta < 90 \text{ mrad}$

- to measure integrated luminosity to better than  $10^{-3}$
- read out by Bean, KPiX

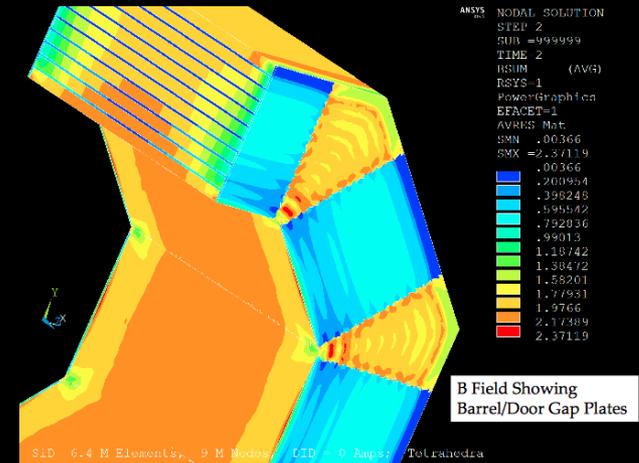
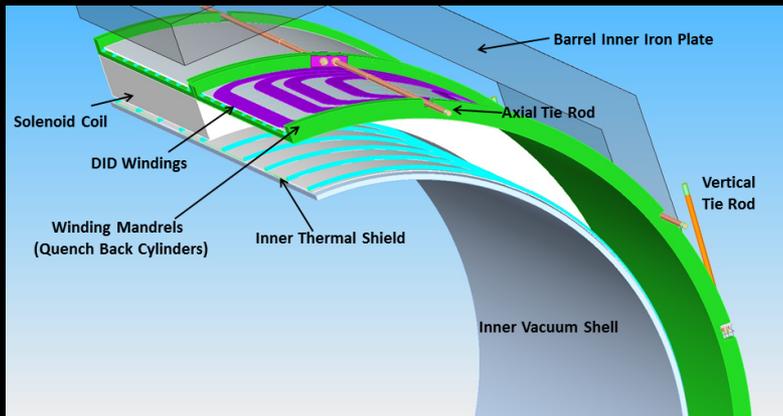
BeamCal:  $3 \text{ mrad} < \theta < 40 \text{ mrad}$

- to measure instantaneous luminosity using pairs
- read out by Bean chip



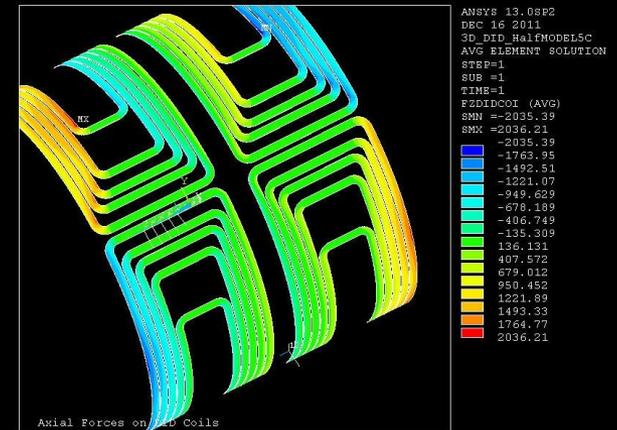
Bean Chip developed for higher radiation dose, high occupancy in far forward region  
180 nm CMOS

# Solenoid



Wes Craddock, SLAC, SiD Workshop, Jan. 2013

- 5 T coil with Detector Integrated Dipole (DID)  
 Coil Design builds on CMS experience.  
 Advances in computation give a significant advantage to the SiD design as compared to prior CMS design work
- Magnetic field calculations in 3D ANSYS model
  - Conservative choice of material. Feasibility demonstrated.
  - Further conductor R&D could lead to cost savings.
- More details in talk by W. Craddock on Tuesday afternoon (via webex)



# Muon

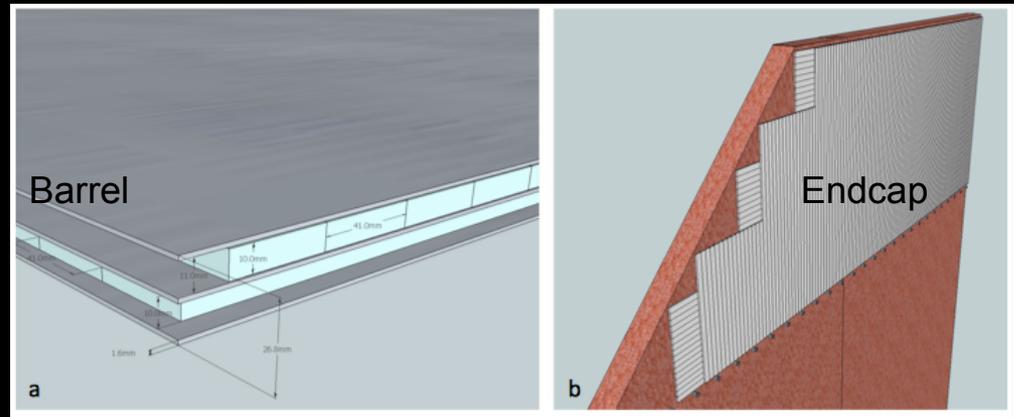
Instrumented Flux  
Return. Main purpose:

- Identification of muons
- Rejection of hadrons

10 layers in barrel,  
9 in each endcap

Major change since LOI:  
RPC → Extruded  
Scintillator bars, SiPM  
readout

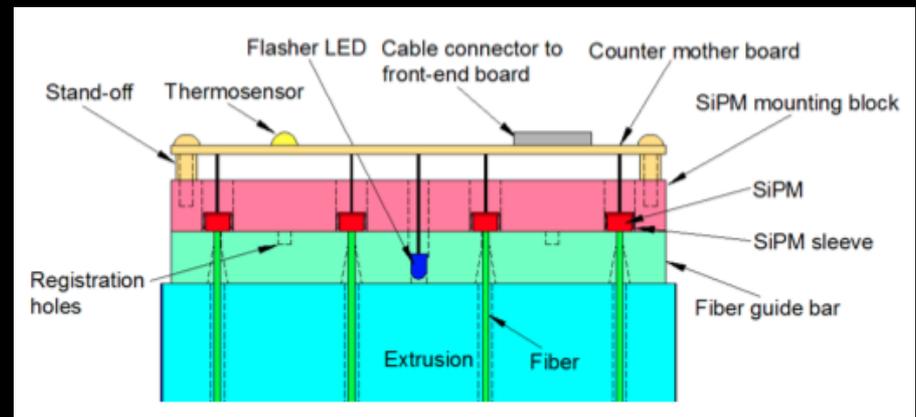
Technology successfully  
tested in FNAL beam.



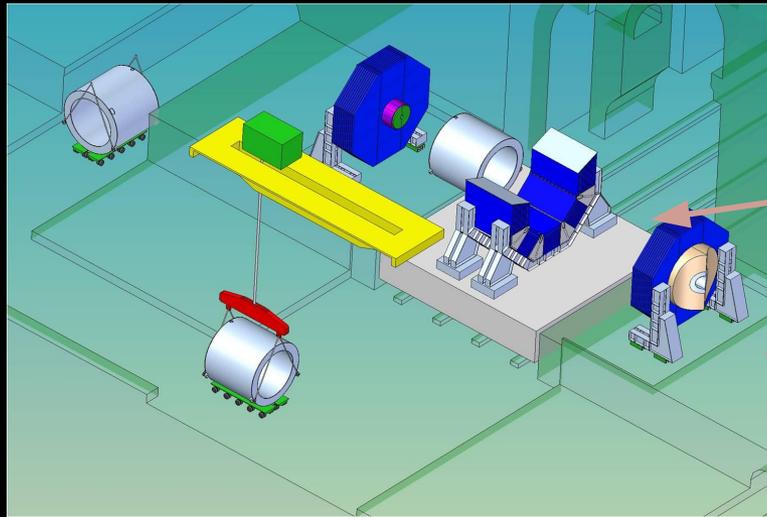
Barrel: Double layers of orthogonal strips, glued together with aluminum sheets

Endcap: Strip size adjusted to fit between spacers

Wavelength-shifting fibers read out by SiPM in a mounting block



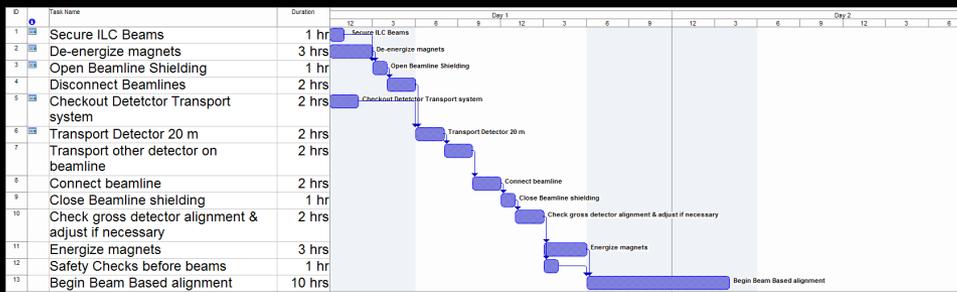
# Engineering and Push-Pull



Horizontal access site

SiD barrel fixed on 3.8 m concrete platform for push-pull

Endcaps can be routinely opened for service



Specific push-pull planning depends on IR layout

"Fastest turnaround that is safely achievable": estimated 32 hrs

# Costing

Costing units agreed between SiD, ILD, CLIC: 2008 USD  
SiD uses central values of agreed costs

Cost of baseline:

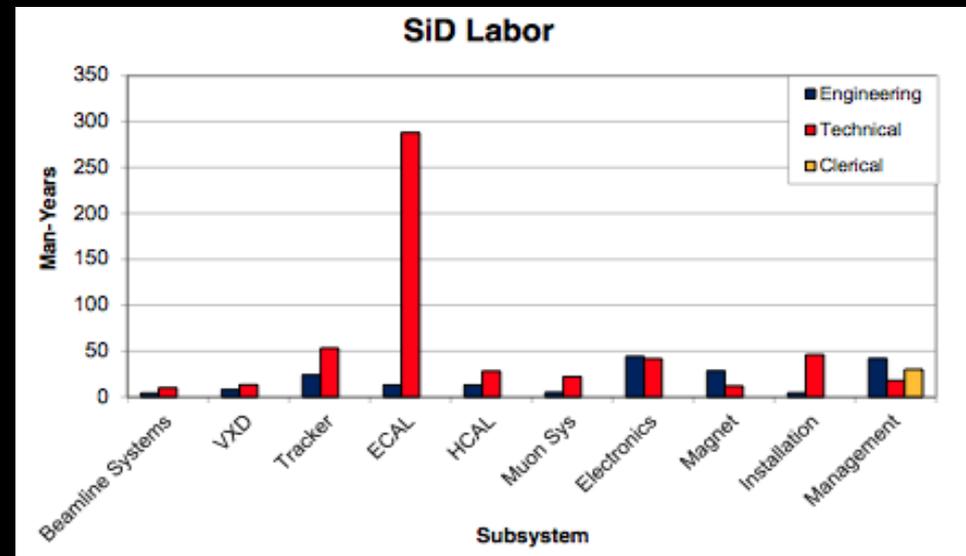
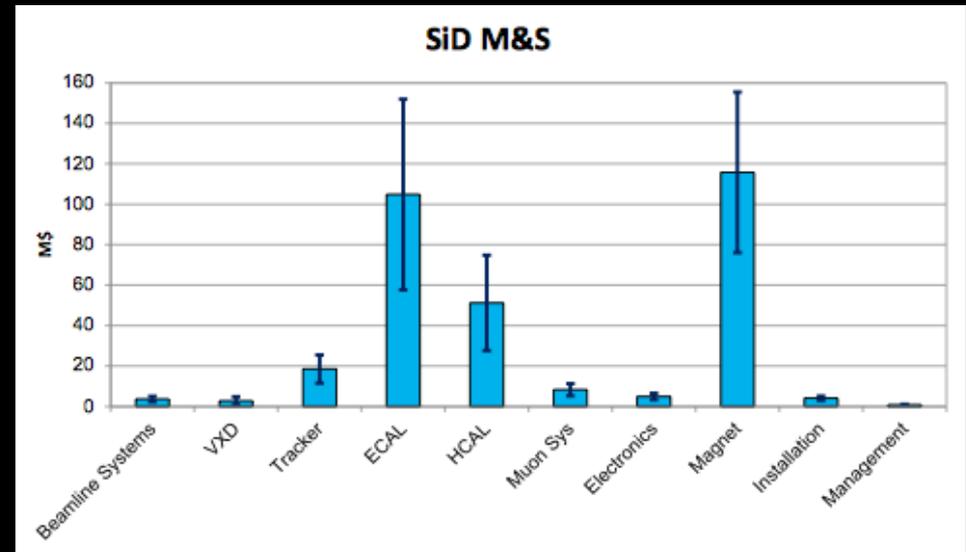
- M&S: 315 MCU
- Contingency: 127 MCU
- Effort: 748 person-years

Parametric detector costing  
→ cost sensitivity analysis

Baseline: 6 CU / cm<sup>2</sup> Si

Coil costed as being made by industry

3 CU / cm<sup>2</sup> Si, coil made in-house, 6000 CU / m<sup>2</sup> HCAL:  
M&S: 315 MCU → 222 MCU



# Detector Baseline Summary

- SiD is designed for precision physics
  - Designed to perform well in worse environment than planned
- Technological feasibility has been shown
  - Detailed studies ongoing
- SiD is fully costed
  - Solid foundation for a TDR
- All the cornerstones are in place
  - We're ready to start a TDR process

# **SiD's Physics Performance**

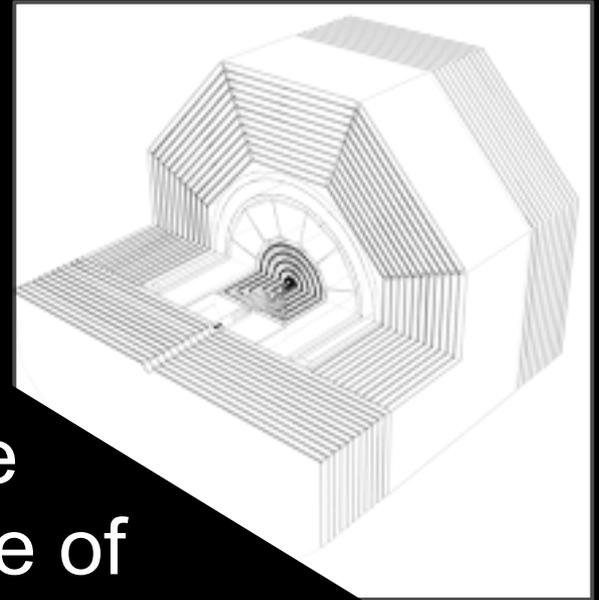
# Simulation

SLIC - developed at SLAC

- Geometry definable at runtime
- XML file allows easy exchange of geometries between collaborators
- Now integrated in ILCSoft

Centerpiece for the DD4HEP project to unify detector description for simulation and reconstruction

See C. Grefe's talk on Tuesday morning



# Reconstruction

Major change since LOI:

Moving to common tools

- PandoraPFA: Calorimeter reconstruction and sophisticated Particle Flow Algorithms
- LCFIPlus: Vertex reconstruction and flavor tagging
- MarlinReco: Collection of analysis tools, e.g. isolated lepton identification
- New OverlayDriver to mix in two kinds of background

Seamless transition enabled by the common LCIO format

# DBD Production in Numbers

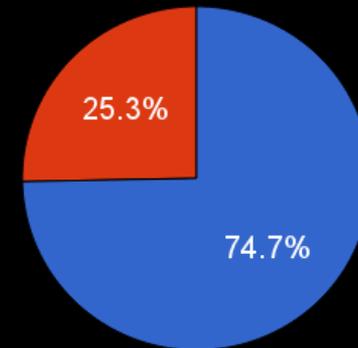
[Production summary](#) on [SLAC confluence](#)

50.7 million events at 1 TeV  
(+ 4.7 million gghadrons)

6.55 million events at 500 GeV  
(+ 4.4 million gghadrons)

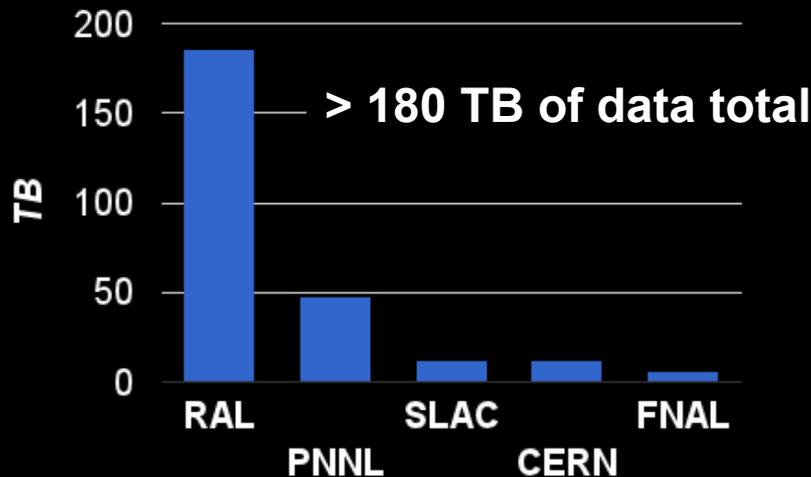
CPU time of different processing stages

Simulation Reconstruction



detailed simulation dominates CPU time budget

## Data Volume



Country	Total CPU Time (years)
UK	100.2
CH	68.2
FR	15.0
US	28.2
<b>TOTAL</b>	<b>211.6</b>

# SiD on the Grid



Open Science Grid (OSG) resources are new addition to the SiD resource pool

dedicated resources: PNNL, SLAC, CERN  
temporary quota increase: FNAL, RAL Tier 1  
opportunistic use: all others



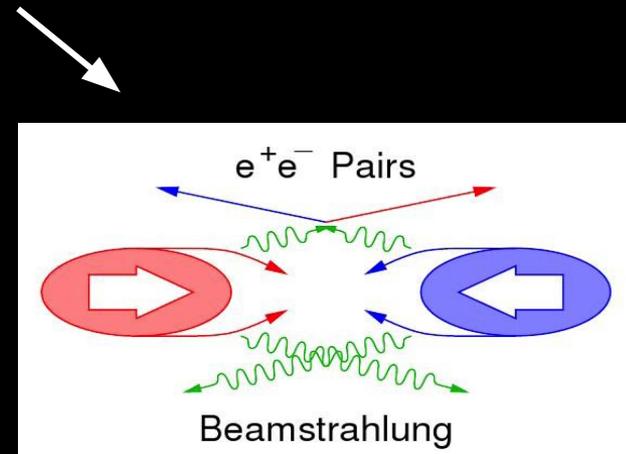
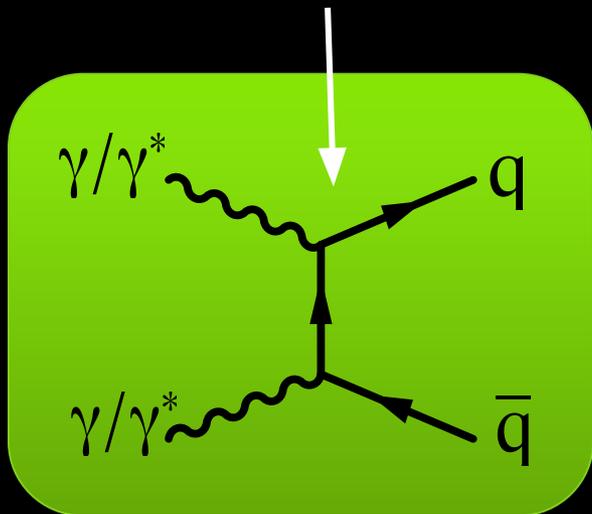
Worldwide LHC Computing Grid (WLCG) resources have been established during LOI and CLIC CDR efforts

SiD takes advantage of the international computing grid infrastructure

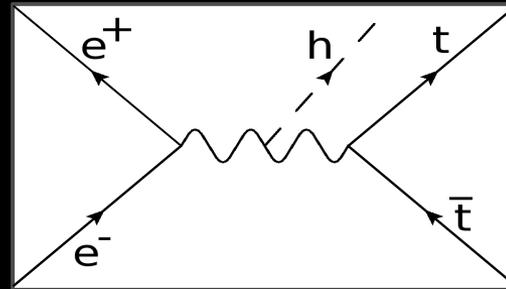
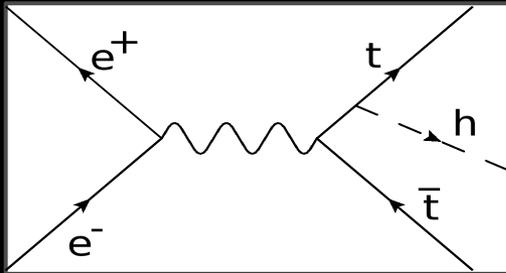
# DBD Benchmarking Analyses

All analyses with detailed detector simulation

- SLIC with realistic (conservative)  $z$  distribution of events across luminous region
- Taking into account background from
- $\gamma\gamma$  interactions and incoherent pairs



# Top Yukawa Coupling



Dominant  $t\bar{t}h$  production diagrams

Direct measurement of the top Yukawa coupling by measuring the  $t\bar{t}h$  cross section at 1 TeV

analysis in 6-jet + 1 lepton and in 8-jet channel;  
candidates formed from jets by minimizing  $\chi^2$

DBD Result:

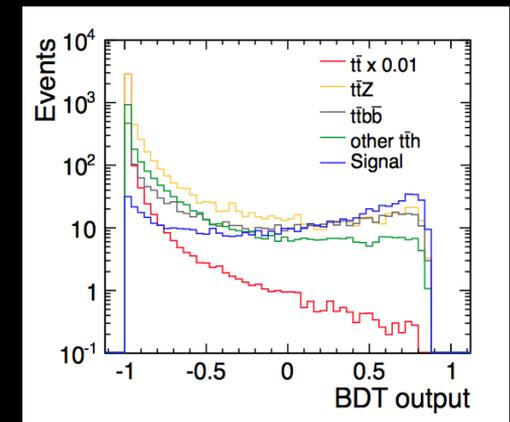
13.2% cross section uncertainty in 6-jet channel

11.5% cross section uncertainty in 8-jet channel

combined uncertainty on the top Yukawa coupling ( $1 \text{ ab}^{-1}$ ): 4.5%

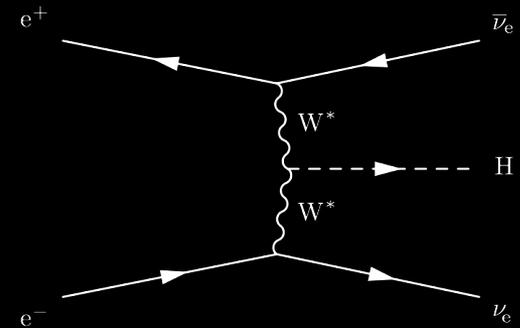
with only  $P_{e^-}, P_{e^+} = -80\%, +20\%$ : uncertainty about 4%

see also Philipp Roloff's talk in the Higgs parallel session for details



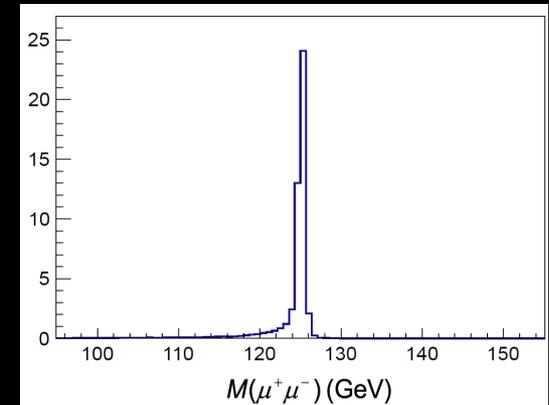
# Higgs Branching Ratios

Measurement of the Higgs branching ratios to  $b, c, g, W, \mu$  pairs (3 separate analyses) in direct production at 1 TeV



Relative uncertainties on the cross section times Higgs BR

Energy	1 TeV		
Luminosity	$\mathcal{L} = 500 \text{ fb}^{-1}$		$\mathcal{L} = 1000 \text{ fb}^{-1}$
$P(e^-)$ $P(e^+)$	- 80%	+ 80%	- 80%
	+ 20%	- 20%	+ 20%
$h \rightarrow bb$	0.0065	0.026	0.0046
$h \rightarrow cc$	0.100	0.733	0.071
$h \rightarrow gg$	0.040	0.234	0.028
$h \rightarrow WW$	0.042	0.260	0.030
$h \rightarrow \mu\mu$			0.32



Results do not take into account results from stages below 1 TeV.

For example,  $h \rightarrow cc$  at 250 GeV,  $250 \text{ fb}^{-1} \approx 6 \%$

some analyses still being updated

quoted uncertainties statistical only

# Top Pair Production at 500 GeV ILC

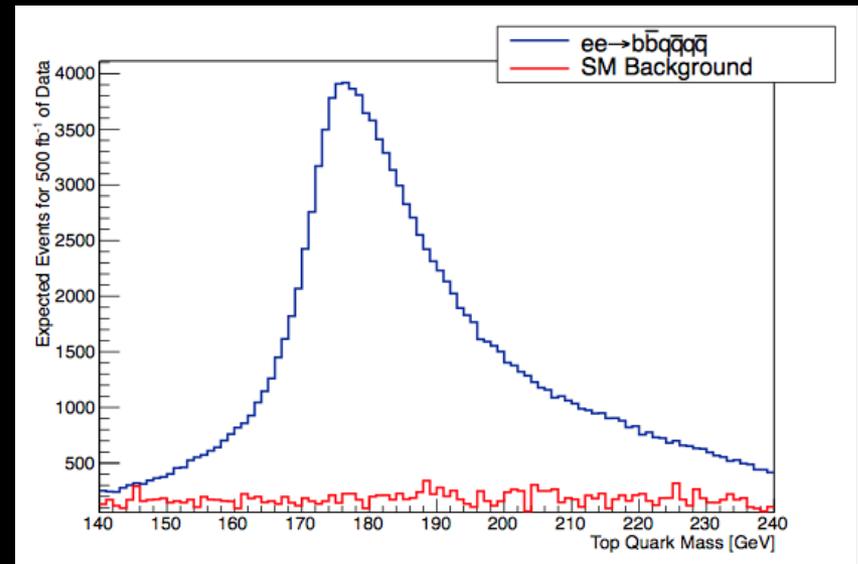
Repetition of a LOI background with updated detector description:

Measurement of top mass and forward-backward asymmetry in top pair production at 500 GeV.

Result with  $500 \text{ fb}^{-1}$ ,  $P_{e^-}$ ,  $P_{e^+} = +80\%$ ,  $-30\%$ :

statistical uncertainty only

- top production cross section:  $< 1\%$
- measurement of forward-backward asymmetry:  $\pm 2\%$



Reconstructed top mass in the fully hadronic channel.

# Summary of Physics Performance

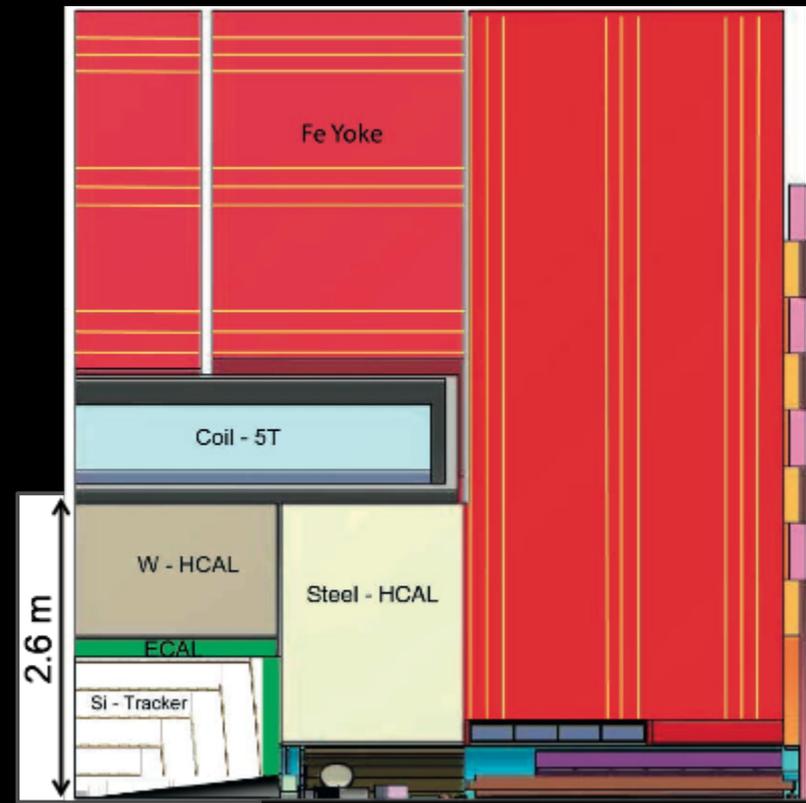
- SiD baseline performance has been demonstrated in realistic simulation studies of precision measurements.
- Excellent b- and c-tagging as well as momentum and jet energy resolution allow to measure the Higgs couplings also to second generation fermions.
- Physics Performance with baseline has been studied up to 1 TeV.

# The SiD Detector Concept at CLIC

Main differences wrt. ILC:

- Larger  $r_{\text{inner}}$  of the vertex detector
- Tungsten absorber in HCAL
- RPC-based muon system
- More complex forward region
- More precise time stamping in the active layers
- Faster power cycling: 50 Hz

more details in talk by C. Grefe



# Summary

- The SiD concept is a compelling option for a detector at a linear collider.
- The SiD concept (with appropriate adjustments of technology) has been successfully used for physics analyses in extensive simulation studies 250 GeV up to 3 TeV.
- The DBD is a snapshot of the SiD road to a TDR.
- **R&D continues, analyses being updated / added for the US "Snowmass Process".**
- **Now is an ideal time to contribute. You are welcome to join the SiD study group meeting on Thursday at 14.00 in Seminar Room 2.**

# Outlook



N. Graf, SLAC

We do not have the ilc, yet, but we will continue to work hard to make sure that the ILC got SiD.

# Thank you, John & Harry

## For

- leading us for nine years and through almost as many reports from DOD to DBD
- your scientific guidance and insight
- keeping SiD together and driving us forward even when times were difficult

Remember “Hotel California”: You can check-out any time you like,  
But you can never leave!



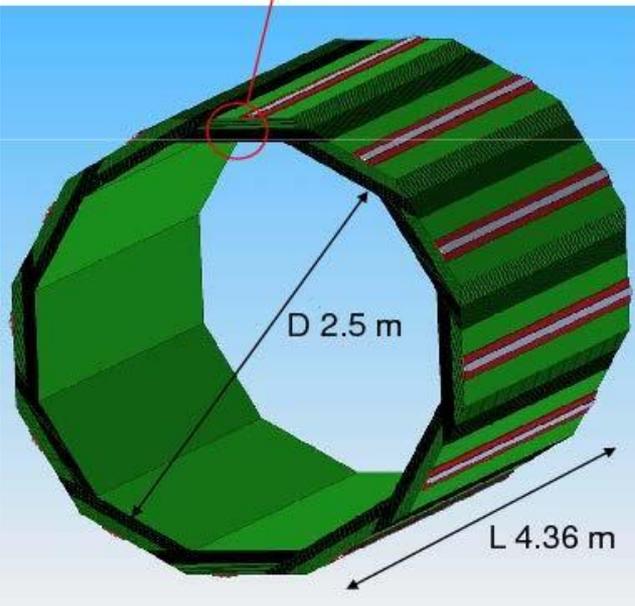
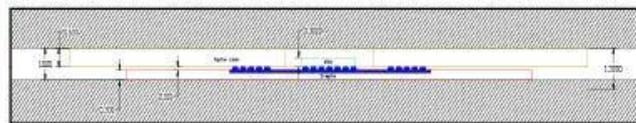
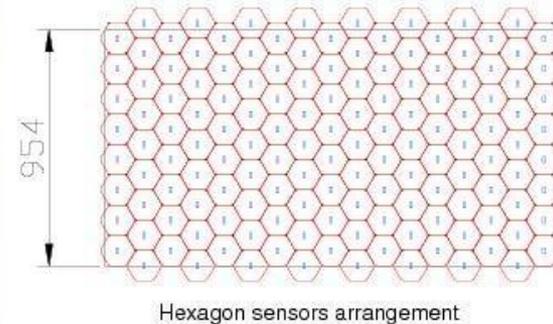
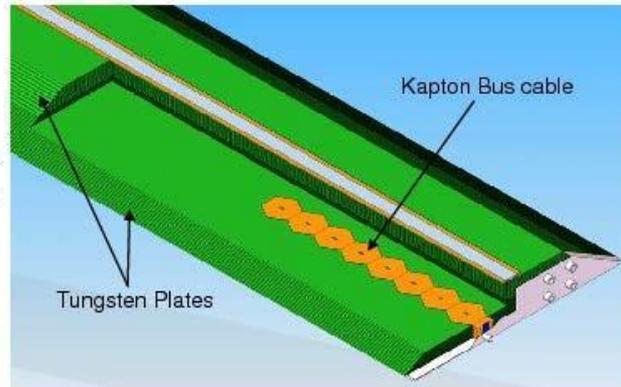
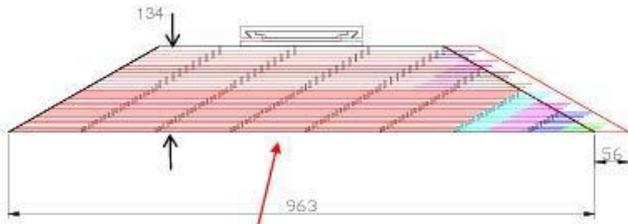
**Thank you for your  
attention**

**Backup**

# The SiD ECal Baseline

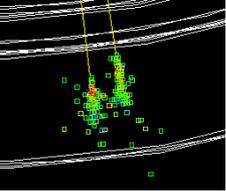


An imaging calorimeter: 30 layers tungsten interleaved with 30 layers pixellated silicon



## Baseline configuration:

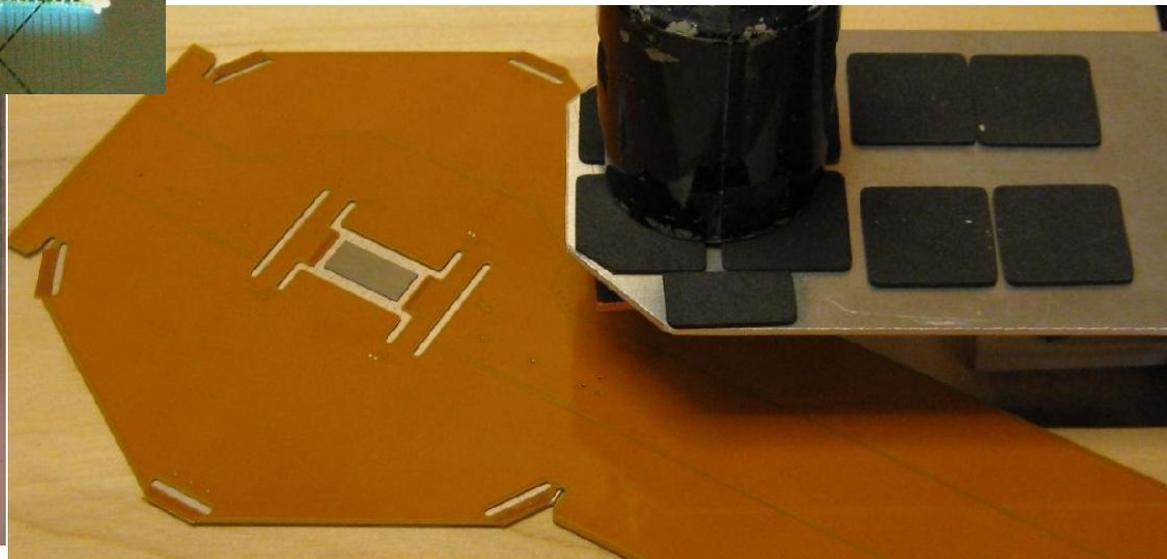
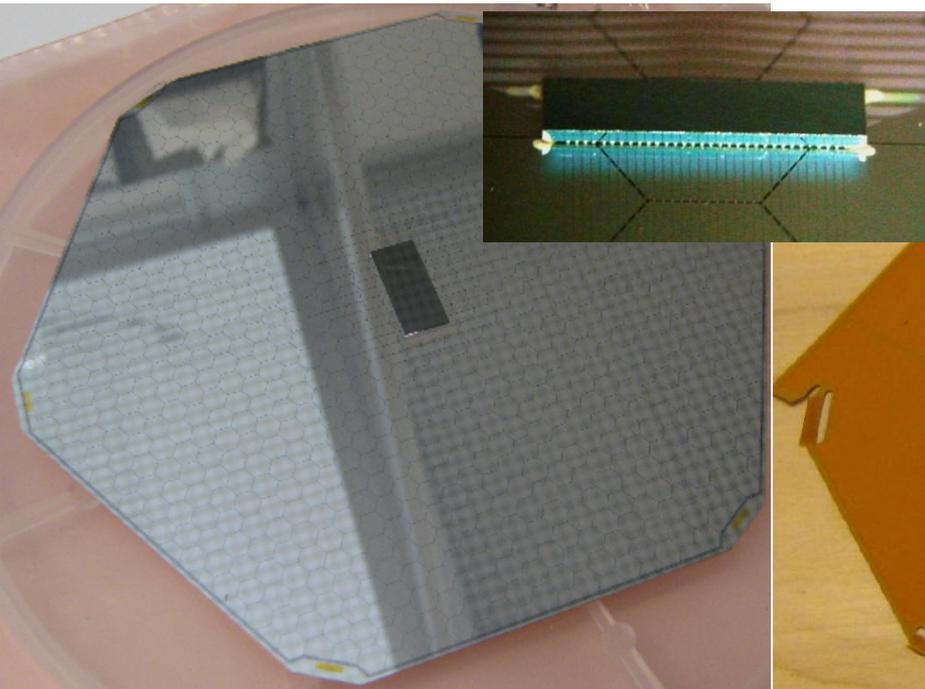
- transverse: 12 mm<sup>2</sup> pixels
- longitudinal: (20 x 5/7 X<sub>0</sub>) + (10 x 10/7 X<sub>0</sub>)  
⇒ 17%/sqrt(E)
- 1 mm readout gaps  
⇒ 13 mm effective Moliere radius

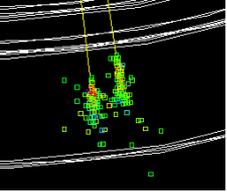


# The R&D program



- Physics: A highly-segmented *imaging* ECal with small Moliere radius which can image MIPs to 500 GeV EM showers without melting
- The key element: a highly integrated electronic readout
  - ~1024 pixel sensors readout and digitized by single chip (KPiX) with power pulsing which is bump-bonded to the sensor
- The R&D provides the required baseline ECal components (except large-scale mechanics) – now nearly completed

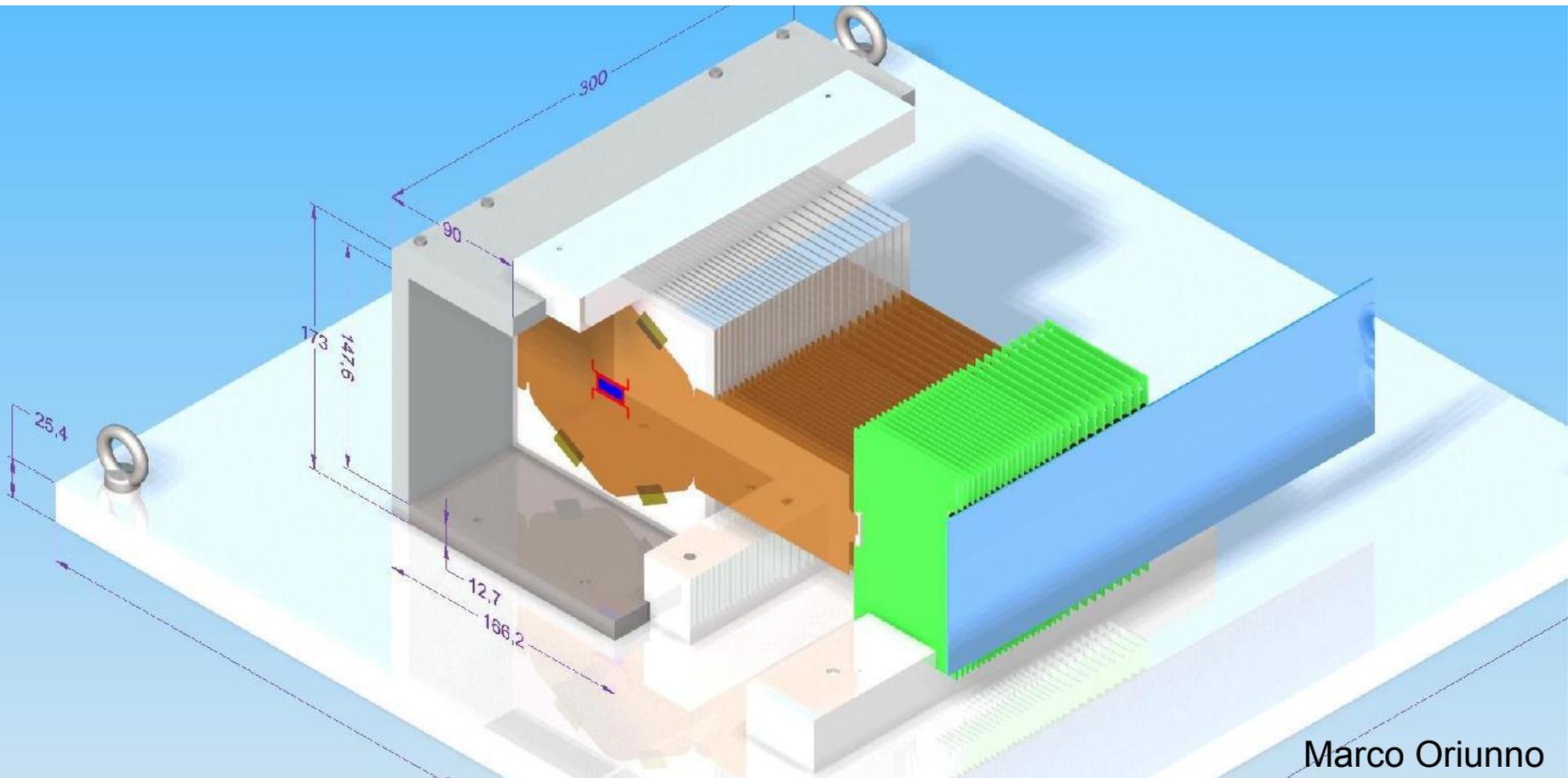




# On to the test beam...

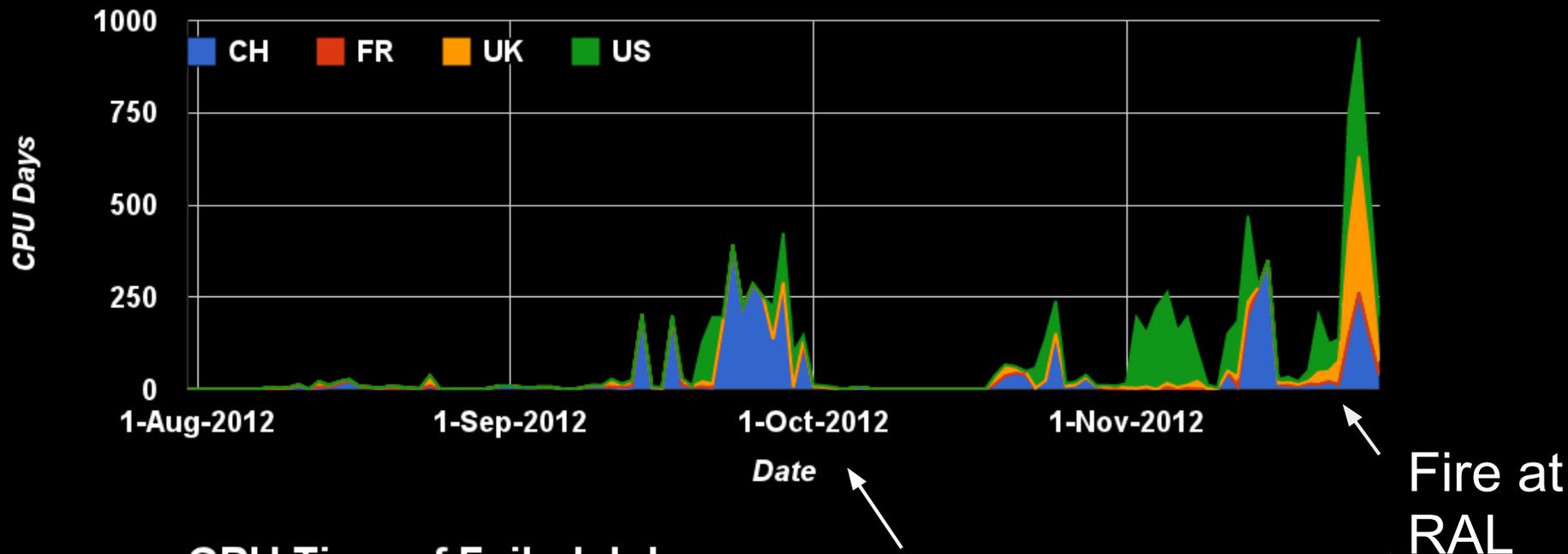


- Scheduled for revived SLAC ESA beamline starting July 2013
- <15 of the full 30 layers; All layers for later running in 2013-14

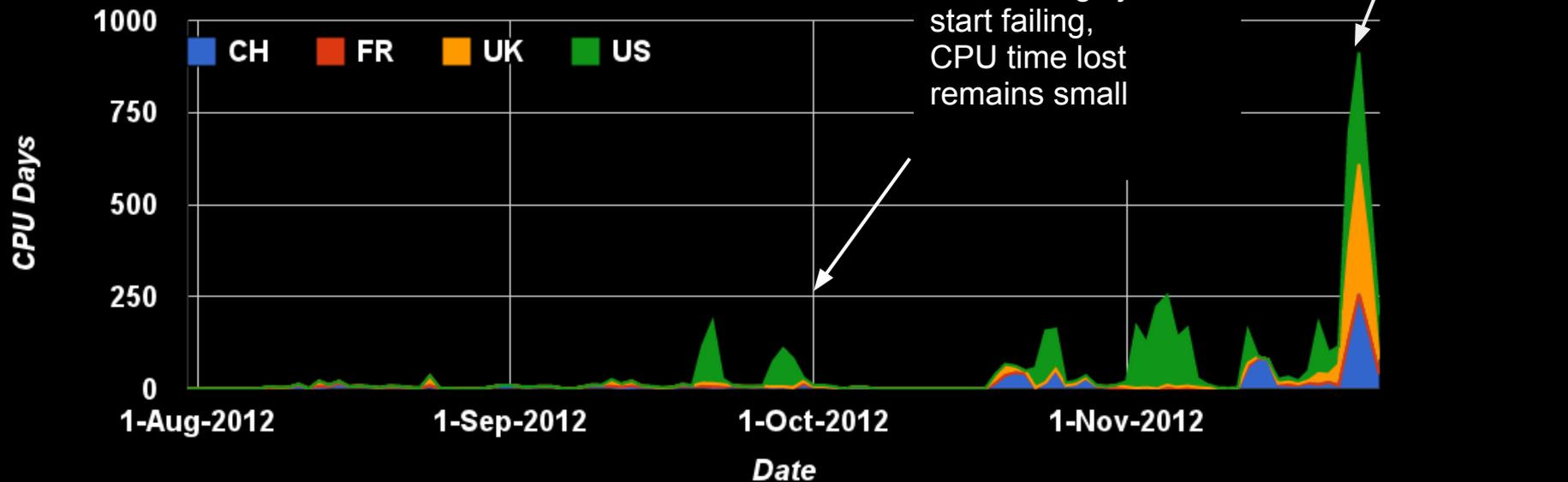


Marco Oriunno

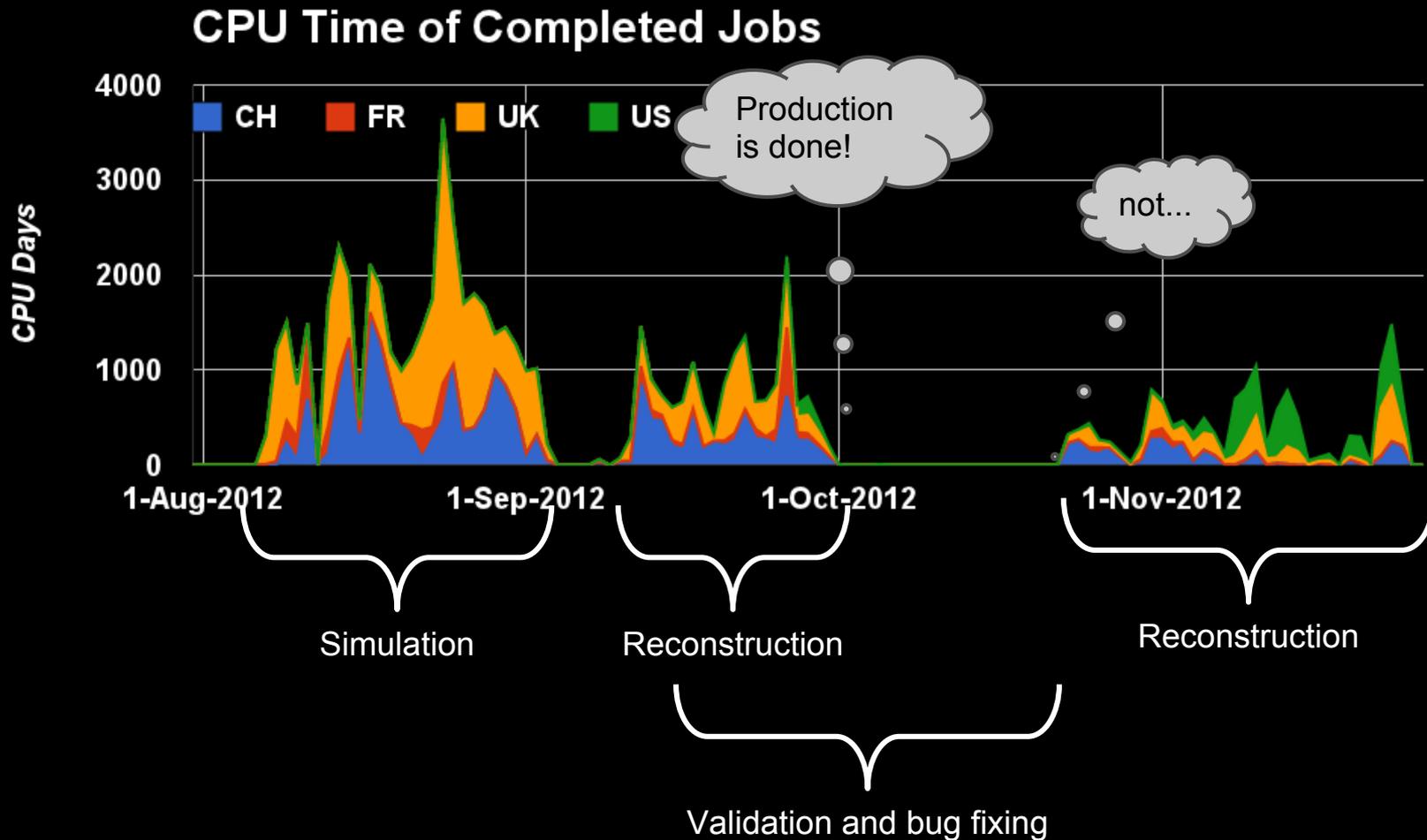
## Number of Failed Jobs



## CPU Time of Failed Jobs

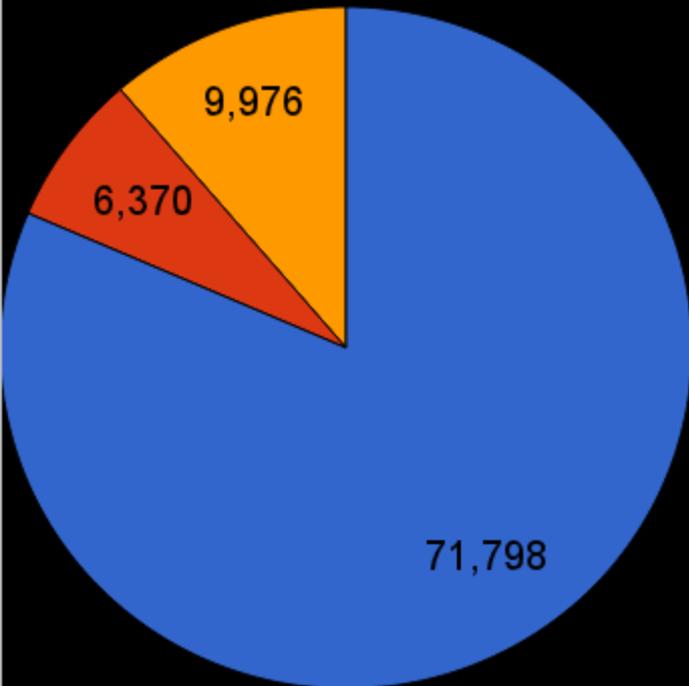


# Production Timeline



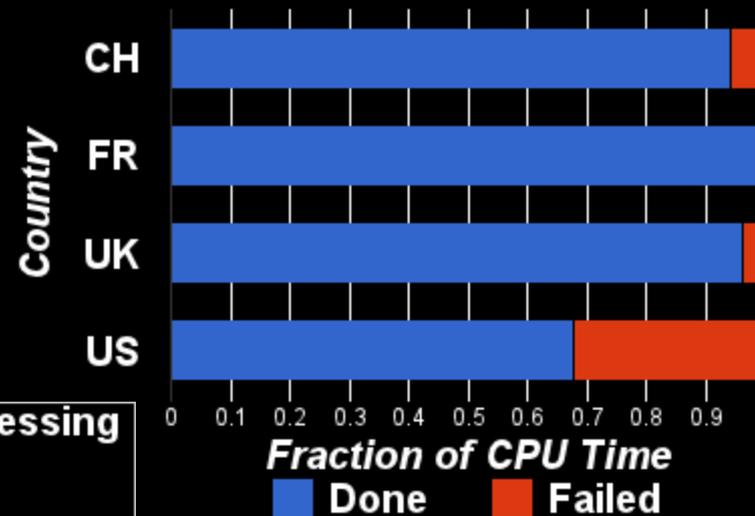
# Performance Summary

## Number of Jobs

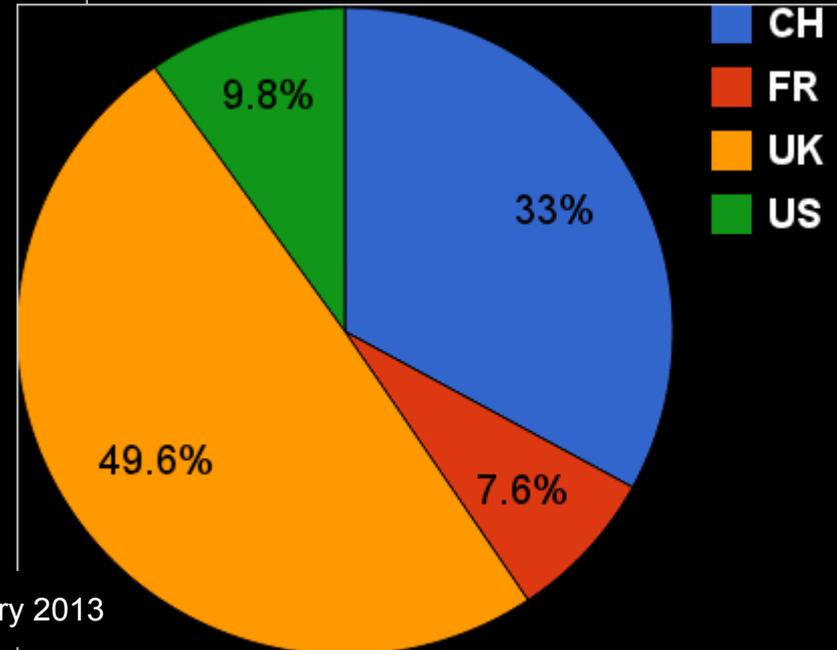


- First Processing Done
- Second Processing Done
- Total Failed

## Performance Breakdown



## CPU Time

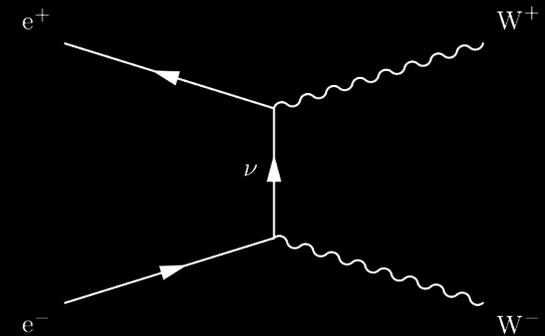


# Measurement of Beam Polarization

$e^+e^- \rightarrow W^+W^-$  production in the forward region  
 Sensitive to polarization,  
 insensitive to new physics.

Four jet topology:  $0.8 < \cos(\theta) < 1$

Two jets + lepton:  $0.8 < \cos(\theta) < 1$  and  
 $-1 < \cos(\theta) < 1$

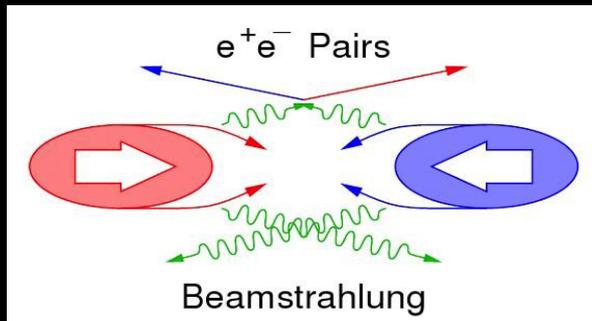


Result:

assuming $500 \text{ fb}^{-1}$ in each polarization state	Pol.	$\Delta P_{e^-} $	$\Delta P_{e^+} $
$0.8 < \cos(\theta) < 1$	-80%,+20%	0.12	0.077
$0.8 < \cos(\theta) < 1$	+80%,-20%	0.0046	0.023
$-1 < \cos(\theta) < 1$	sum	0.0020	0.0029

assuming SM production of  $W^+W^-$

# Beam-Induced Background

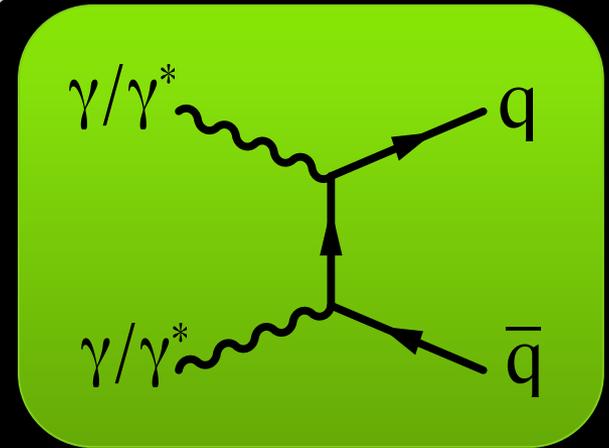


Pair background  
1 event per BX  
450k particles

Generated by  
GuineaPig  
ascii → hepevt →  
stdhep

Merged with  
each “physics”  
event

MCParticles  
that don't  
make hits are  
dropped



$\gamma\gamma$  interactions

4.1 events per BX @ 1 TeV  
1.7 events per BX at 500 GeV

Generated by Whizard

Baseline	M&S Base (M\$)	M&S Conti ngen cy (M\$)	Enginee ring (MY)	Technic al (MY)	Administ rative (MY)
Beamline Systems	3.7	1.4	4.0	10.0	0.0
VXD	2.8	2.0	8.0	17.7	0.0
Tracker	17.7	6.9	24.0	53.2	0.0
EMCal	99.9	40.0	13.0	298.9	0.0
Hcal	51.6	20.1	13.0	28.0	0.0
Muon Sys	8.3	2.9	5.0	14.6	0.0
Electronics	4.9	1.6	44.1	41.7	0.0
Magnet	114.8	39.5	29.2	25.0	0.0
Installation	4.1	1.1	4.5	46.0	0.0
Management	0.9	0.2	42.0	18.0	30.0
	308.8	115.7	186.8	553.1	30.0

Modified Costing	M&S Base (M\$)	M&S Contingency (M\$)	Engineering (MY)	Technical (MY)	Administrative (MY)
Beamline Systems	3.7	1.4	4.0	10.0	0.0
VXD	2.8	2.0	8.0	17.7	0.0
Tracker	14.4	5.7	24.0	53.2	0.0
EMCal	63.5	25.4	13.0	298.9	0.0
Hcal	30.6	11.7	13.0	28.0	0.0
Muon Sys	8.3	2.9	5.0	14.6	0.0
Electronics	4.9	1.6	44.1	41.7	0.0
Magnet	88.9	30.4	29.2	25.0	0.0
Installation	4.1	1.1	4.5	46.0	0.0
Management	0.9	0.2	42.0	18.0	30.0
	222.1	82.4	186.8	553.1	30.0